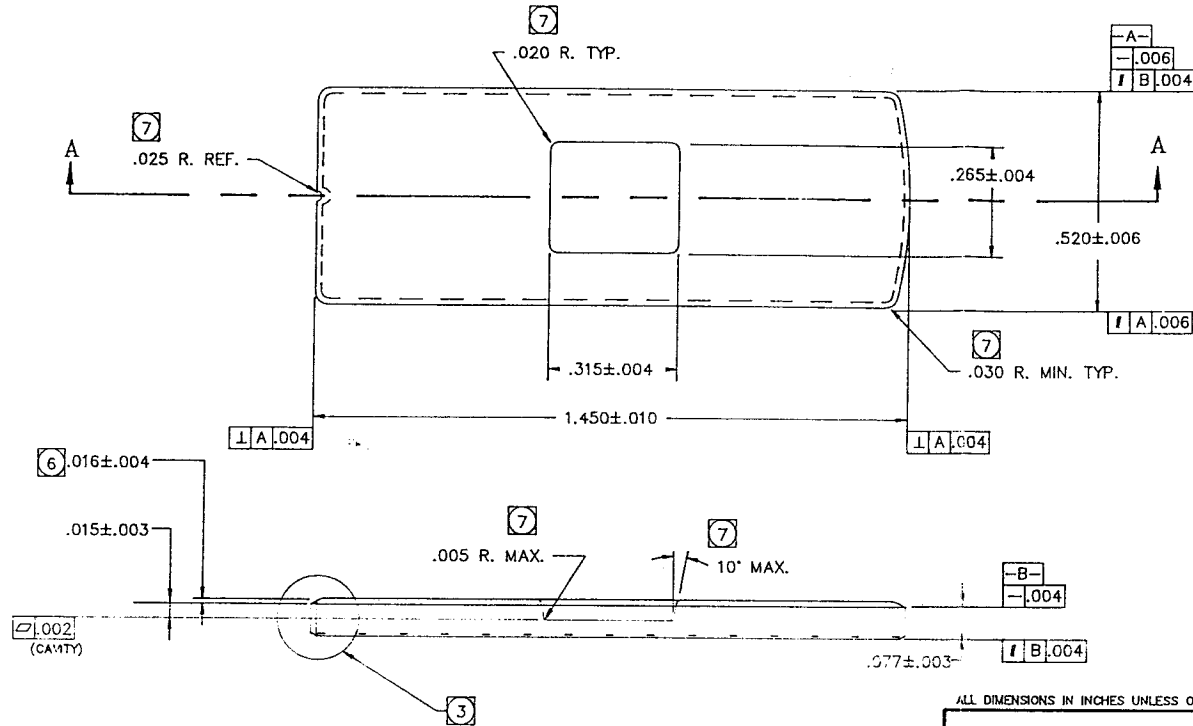


REV. LET.	REVISION DESCRIPTION	DRAWN BY	ECN NO.	DATE
C	CHANGES TO NOTES & FORMAT	VJH	62050	1/14/94



NOTES:

1. QUALITY CONTROL REQUIREMENTS SHALL BE IN ACCORDANCE WITH 279.
2. MATERIAL AND CONSTRUCTION IN COMPLIANCE TO THE LATEST REVISION (PLUS AMMENDMENTS) OF MIL-M-38535.
3. CERAMIC BODY TO HAVE VENDOR'S STANDARD CHIP RESISTANCE DESIGN.
4. CAVITY METALLIZATION THICKNESS: 200 MICROINCH MIN. GOLD.
5. GLASS PULLBACK: (A)  $.010$  MAX. IN THE CRITICAL SEAL AREA (INCLUDING THE CAVITY WALL). (B)  $.015$  MAX. OUTSIDE THE CRITICAL SEAL AREA.
6. SEAL GLASS: IWAKI T-187 DRY PROCESS OR APPROVED EQUIVALENT.
7. FEATURES MARKED WITH THIS DESIGNATION NON CRITICAL, NOT TO BE INSPECTED.

VENDOR INFO = REF. TO DOC. 70C00804

LID CATALOG NUMBER	LID DWG. NO.
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ALL DIMENSIONS IN INCHES UNLESS OTHERWISE SPECIFIED

THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION FOR ANY PURPOSE EXCEPT AS PROVIDED IN A CONTRACT, IF ANY, UNDER WHICH THIS DOCUMENT WAS SUPPLIED		SHALL NOT BE PUBLISHED, REPRODUCED, COPIED, OR USED	
VERNA JIU HSIAO	12/17/93	<h1>CDB02870</h1>	
DRAWN	DATE		
CHECKED	DATE	TOLERANCE UNLESS OTHERWISE SPECIFIED	CATALOG NO.
APP FOR PRODUCTION	DATE	.XXX DECIMAL $\pm .005$	X DECIMAL $\pm .03$
FINISH	DATE	.XX DECIMAL $\pm .010$	FRACTIONAL $\pm$
MATERIAL	DATE		ANGULAR $\pm 0^\circ 30'$
			SURFACE ROUGHNESS

TITLE: 28 LEAD CERDIP BASE  
.315 X .265 MSI

**A28-0297-10RA-1L**